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With the principle of "Quality Parts,Customers Priority,Honest Operation,and Considerate Service",our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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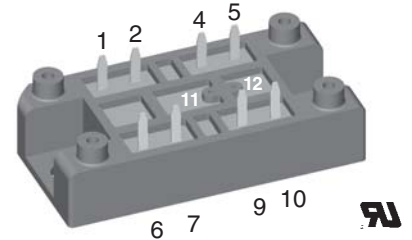
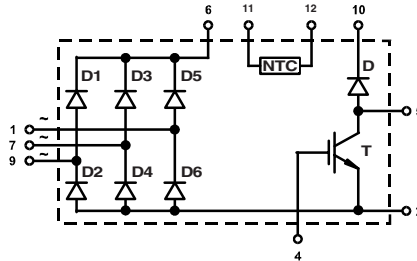
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Three Phase Rectifier Bridge with Brake Chopper

$V_{RRM} = 1200/1600 \text{ V}$
 $I_{dAVM} = 110 \text{ A}$



Input Rectifier D1 - D6

Symbol	Conditions	Maximum Ratings	
V_{RRM}	VUB 72 -12 NO1	1200	V
	VUB 72 -16 NO1	1600	V
I_{FAV}	$T_C = 80^\circ\text{C}$; sine 180°	40	A
I_{DAVM}	$T_C = 80^\circ\text{C}$; rectangular; $d = 1/3$; bridge	110	A
I_{FSM}	$T_{VJ} = 25^\circ\text{C}$; $t = 10 \text{ ms}$; sine 50 Hz	530	A
P_{tot}	$T_C = 25^\circ\text{C}$	100	W

Features

- three phase mains rectifier
- brake chopper:
 - IGBT with low saturation voltage
 - HiPerFRED™ free wheeling diode
- module package:
 - high level of integration
 - solder terminals for PCB mounting
 - UL registered E72873
 - isolated DCB ceramic base plate
 - large creepage and strike distances
 - high reliability

Symbol	Conditions	Characteristic Values ($T_{VJ} = 25^\circ\text{C}$, unless otherwise specified)		
		min.	typ.	max.
V_F	$I_F = 25 \text{ A}$; $T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = 125^\circ\text{C}$	1.0	1.1	V
		0.9		V
I_R	$V_R = V_{RRM}$; $T_{VJ} = 25^\circ\text{C}$ $V_R = 0.8 \cdot V_{RRM}$; $T_{VJ} = 125^\circ\text{C}$		0.02	mA
		0.4		mA
R_{thJC}	per diode		1.2	K/W
R_{thJH}	with heat transfer paste		1.42	K/W

Applications

- drives with
- mains input
 - DC link
 - inverter or chopper feeding the machine
 - motor and generator/brake operation

Chopper Diode D

Symbol	Conditions	Maximum Ratings	
V_{RRM}	$T_{VJ} = 25^\circ\text{C}$ to 150°C	1200	V
I_{F25}	DC; $T_C = 25^\circ\text{C}$	25	A
I_{F80}	DC; $T_C = 80^\circ\text{C}$	15	A

Symbol	Conditions	Characteristic Values		
		min.	typ.	max.
V_F	$I_F = 25 \text{ A}$; $T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = 125^\circ\text{C}$	2.7	3.1	V
		2.0		V
I_R	$V_R = V_{RRM}$; $T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = 125^\circ\text{C}$	0.1	0.1	mA
I_{RM}	$I_F = 15 \text{ A}$; $di_F/dt = -400 \text{ A}/\mu\text{s}$ $V_R = 600 \text{ V}$; $T_{VJ} = 125^\circ\text{C}$	16		A
t_{rr}		130		ns
R_{thJC}	with heat transfer paste		2.3	K/W
R_{thJH}			3.12	K/W

IXYS reserves the right to change limits, test conditions and dimensions.

Chopper Transistor T

Symbol	Conditions	Maximum Ratings	
V_{CES}	$T_{VJ} = 25^{\circ}\text{C}$ to 150°C	1200	V
V_{GES}		± 20	V
I_{C25}	DC; $T_C = 25^{\circ}\text{C}$	50	A
I_{C80}	DC; $T_C = 80^{\circ}\text{C}$	35	A
I_{CM}	$V_{GE} = \pm 15\text{ V}$; $R_G = 39\ \Omega$; $T_{VJ} = 125^{\circ}\text{C}$	50	A
V_{CEK}	RBSOA; $L = 100\ \mu\text{H}$	V_{CES}	
t_{SC} (SCSOA)	$V_{GE} = \pm 15\text{ V}$; $V_{CE} = 900\text{ V}$; $T_{VJ} = 125^{\circ}\text{C}$ $R_G = 39\ \Omega$; non repetitive	10	μs

Symbol	Conditions ($T_{VJ} = 25^{\circ}\text{C}$, unless otherwise specified)	Characteristic Values		
		min.	typ.	max.
$V_{CE(sat)}$	$I_C = 25\text{ A}$; $V_{GE} = 15\text{ V}$; $T_{VJ} = 25^{\circ}\text{C}$ $T_{VJ} = 125^{\circ}\text{C}$	1.9 2.1	2.4	V V
$V_{GE(th)}$	$I_C = 1\text{ mA}$; $V_{GE} = V_{CE}$	4.5	6.5	V
I_{CES}	$V_{CE} = V_{CES}$; $V_{GE} = 0\text{ V}$; $T_{VJ} = 25^{\circ}\text{C}$ $T_{VJ} = 125^{\circ}\text{C}$	0.1	0.1	mA mA
I_{GES}	$V_{CE} = 0\text{ V}$; $V_{GE} = \pm 20\text{ V}$		200	nA
$t_{d(on)}$ t_r $t_{d(off)}$ $t_{E_{on}}$ $t_{E_{off}}$	Inductive load, $T_{VJ} = 125^{\circ}\text{C}$ $V_{CE} = 600\text{ V}$; $I_C = 25\text{ A}$ $V_{GE} = \pm 15\text{ V}$; $R_G = 39\ \Omega$		80	ns
			50	ns
			440	ns
			50	ns
			3.8	mJ
E_{off}		2.0	mJ	
C_{ies}	$V_{CE} = 25\text{ V}$; $V_{GE} = 0\text{ V}$; $f = 1\text{ MHz}$	2.0		nF
Q_{Gon}	$V_{CE} = 600\text{ V}$; $V_{GE} = 15\text{ V}$; $I_C = 35\text{ A}$	150		nC
R_{thJC}			0.6	K/W
R_{thJH}	with heat transfer paste, see mounting instructions		1.2	K/W

Temperature Sensor NTC

Symbol	Conditions	Characteristic Values typ.	
R_{25}	$T = 25^{\circ}\text{C}$	2.2	k Ω
$B_{25/100}$	$R(T) = R_{25} \cdot e^{B_{25/100} \left(\frac{1}{T} - \frac{1}{298\text{K}} \right)}$	3560	K

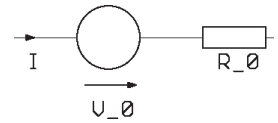
Module

Symbol	Conditions	Maximum Ratings	
I_{RMS}	per pin	100	A
T_{VJ}		-40...+150	$^{\circ}\text{C}$
T_{stg}		-40...+125	$^{\circ}\text{C}$
V_{ISOL}	$I_{ISOL} \leq 1\text{ mA}$; 50/60 Hz; $t = 1\text{ min}$	3600	V~
M_d	Mounting torque (M5)	2 - 2.5	Nm

Symbol	Conditions	Characteristic Values		
		min.	typ.	max.
d_A, d_S		5		mm
Weight		35		g

Equivalent Circuits for Simulation

Conduction



D1 - D6

Diode (typ. at $T_J = 125^{\circ}\text{C}$)

$$V_0 = 0.85\text{ V}; R_0 = 7\text{ m}\Omega$$

T/D

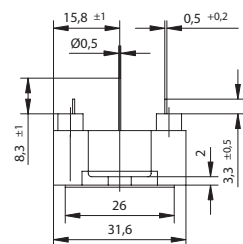
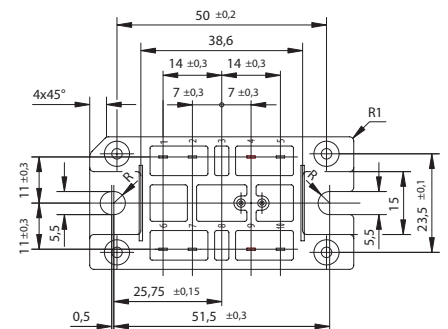
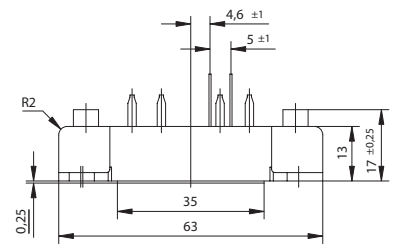
IGBT (typ. at $V_{GE} = 15\text{ V}$; $T_J = 125^{\circ}\text{C}$)

$$V_0 = 1.0\text{ V}; R_0 = 45\text{ m}\Omega$$

Free Wheeling Diode (typ. at $T_J = 125^{\circ}\text{C}$)

$$V_0 = 1.25\text{ V}; R_0 = 32\text{ m}\Omega$$

Dimensions in mm (1 mm = 0.0394")



Input Rectifier D1-D6

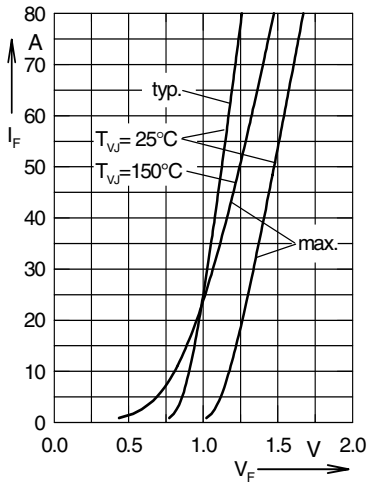


Fig. 1 Forward current vs. voltage drop per rectifier diode

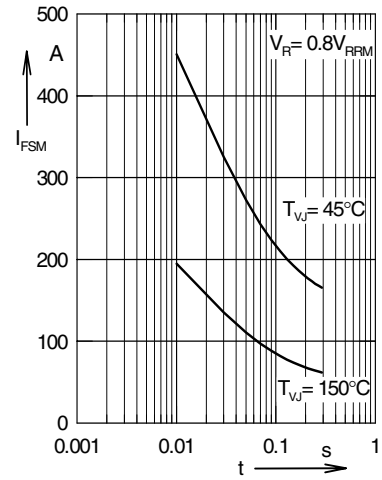


Fig. 2 Surge overload current per rectifier diode

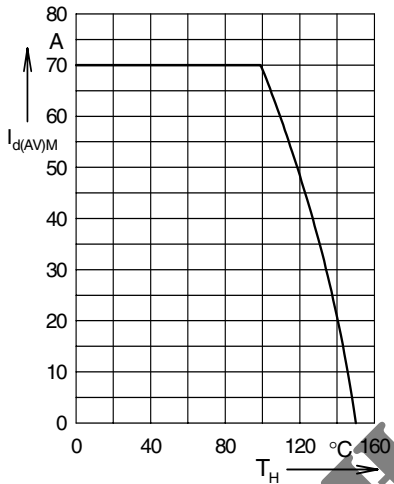


Fig. 3 Maximum forward current vs. heatsink temperature (Rectifier bridge)

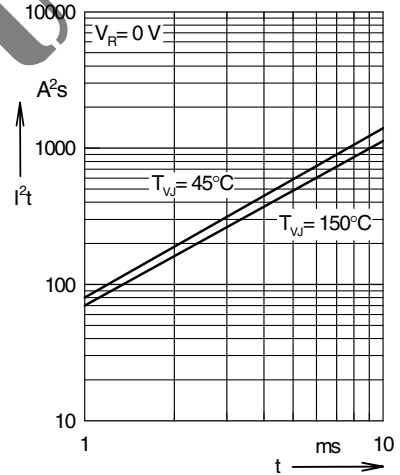


Fig. 4 I^2t versus time per rectifier diode

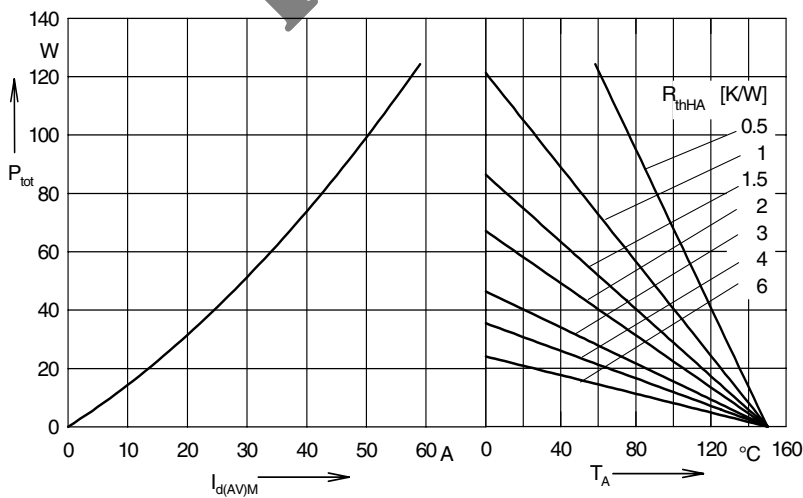


Fig. 5 Power dissipation vs. direct output current and ambient temperature (Rectifier bridge)

Note:
Transient thermal impedance
see next page

Chopper T - D

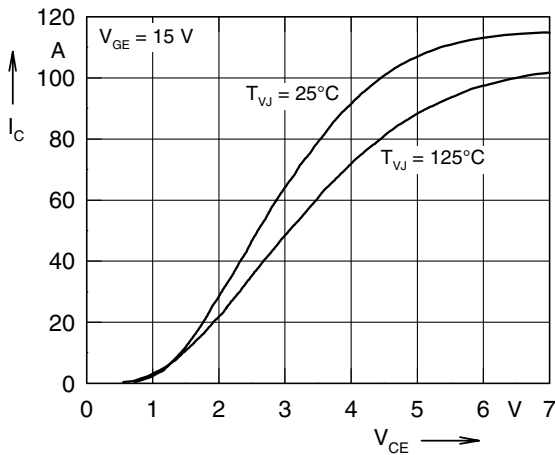


Fig. 6 Typ. IGBT output characteristics

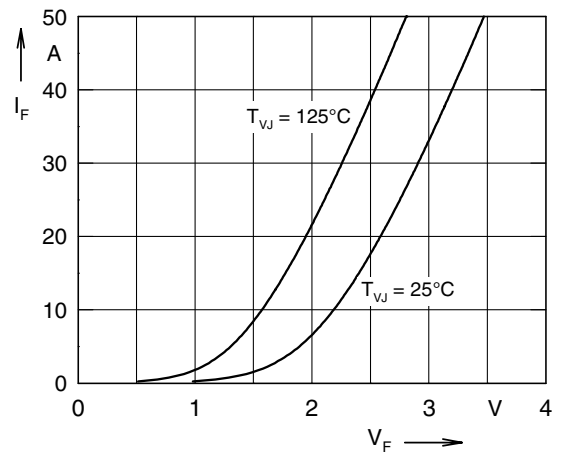


Fig. 7 Typ. forward characteristics of free wheeling diode

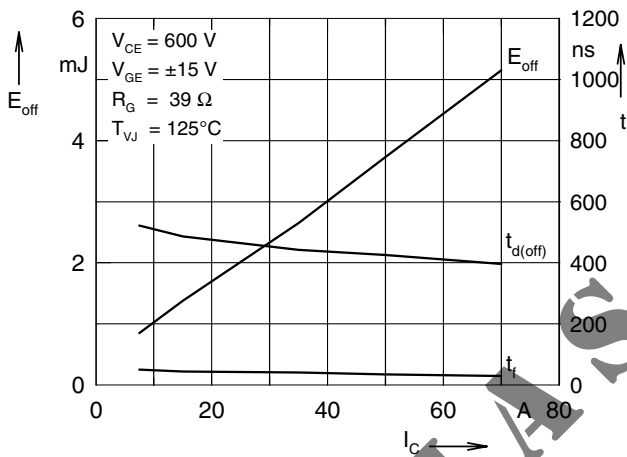


Fig. 8 Typ. IGBT turn off energy and switching times versus collector current

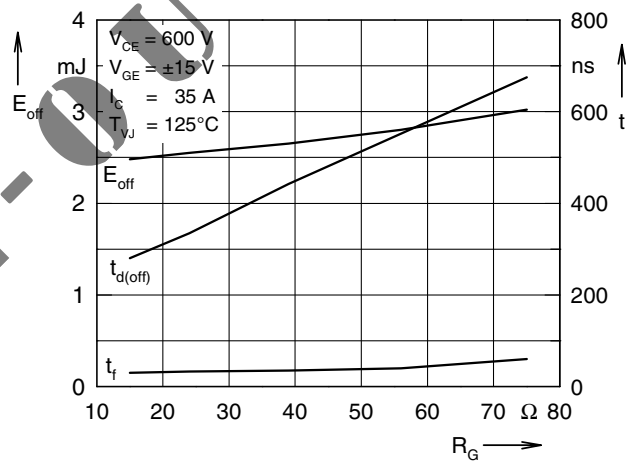


Fig. 9 Typ. IGBT turn off energy and switching times versus gate resistor

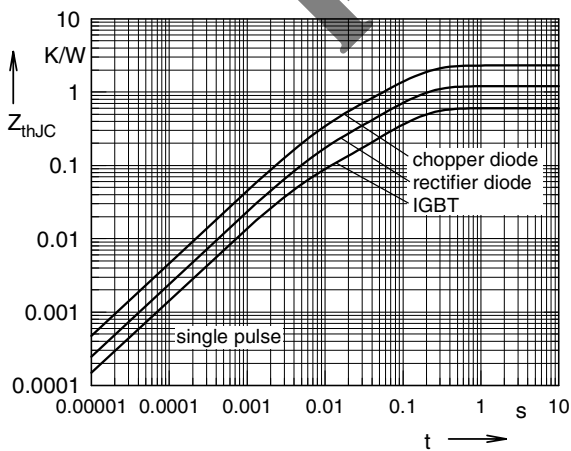


Fig. 10 Typ. transient thermal impedance

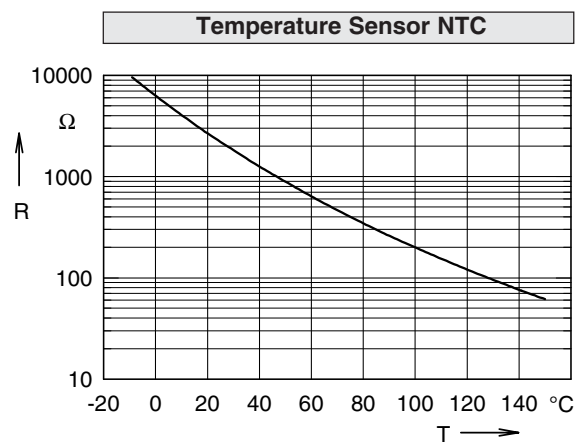


Fig. 11 Typ. thermistorresistance versus temperature